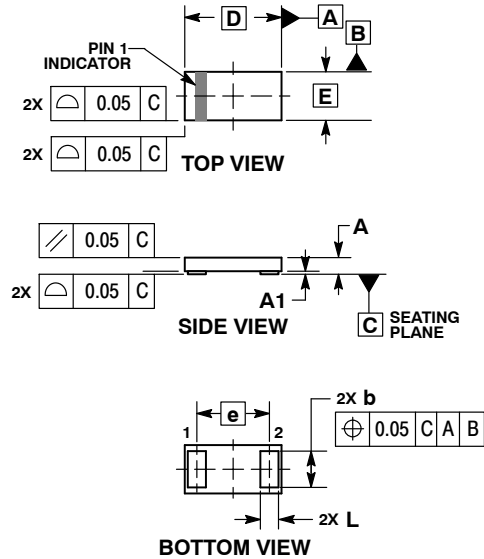


SCALE 8:1

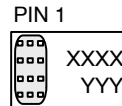
DSN2, 1.6x0.8, 1.2P, (0603)
CASE 152AT
ISSUE A

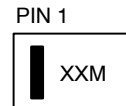
DATE 03 JUN 2016


NOTES:

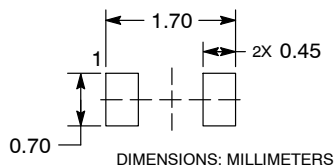
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.

MILLIMETERS		
DIM	MIN	MAX
A	0.25	0.31
A1	0.00	0.05
b	0.55	0.65
D	1.60	BSC
E	0.80	BSC
e	1.20	BSC
L	0.25	0.35

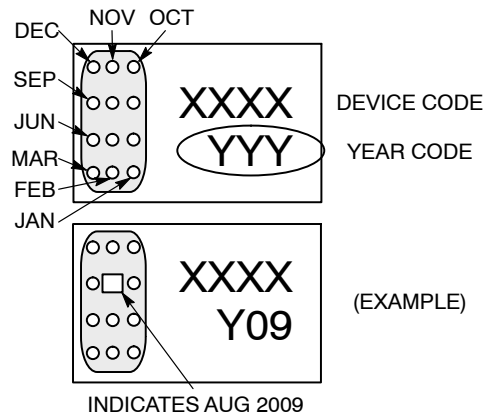
GENERIC MARKING DIAGRAM1*

XXXX = Specific Device Code
YYY = Year Code

GENERIC MARKING DIAGRAM2*

XX = Specific Device Code
M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present.

RECOMMENDED MOUNTING FOOTPRINT*

See Application Note [AND8464/D](#) for more mounting details

*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, [SOLDERRM/D](#).

CATHODE BAND MONTH CODING


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DESCRIPTION:	DSN2, 1.6X0.8, 1.2P, (0603)	PAGE 1 OF 1

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